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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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ON

FDMC008N08C N-Channel Shielded Gate PowerTrench[®] MOSFET

80 V, 60 A, 7.8 mΩ

Features

- Shielded Gate MOSFET Technology
- Max r_{DS(on)} = 7.8 mΩ at V_{GS} = 10 V, I_D =21 A
- Max $r_{DS(on)}$ = 19.3 m Ω at V_{GS} = 6 V, I_D = 10 A
- 50% lower Qrr than other MOSFET suppliers
- Lowers switching noise/EMI
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

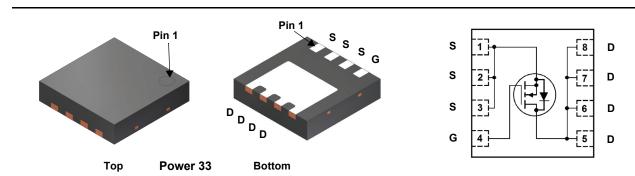


General Description

This N-Channel MV MOSFET is produced using ON Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized to minimise on-state resistance and yet maintain superior switching performance with best in class soft body diode.

Applications

- Primary DC-DC MOSFET
- Synchronous Rectifier in DC-DC and AC-DC
- Motor Drive
- Solar



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			80	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T _C = 25 °C	(Note 5)	60		
	-Continuous	T _C = 100 °C	(Note 5)	38	Α	
	-Continuous	T _A = 25 °C	(Note 1a)	12		
	-Pulsed		(Note 4)	273		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	150	mJ	
P _D	Power Dissipation	T _C = 25 °C		57	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	
Thermal Ch	naracteristics					
R _{θJC}	Thermal Resistance, Junction to Case			2.2	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		(Note 1a)	53		

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
008N08C	FDMC008N08C	Power 33	13 "	12 mm	3000 units

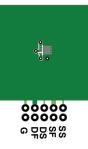
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	80			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		51		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 64 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20 V, V _{DS} = 0 V			100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 120 μA	2.0	3.0	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 120 \ \mu\text{A}$, referenced to 25 °C		-8.4		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 21 A		6.3	7.8	mΩ
		$V_{GS} = 6 V, I_D = 10 A$		9.6	19.3	
		V _{GS} = 10 V, I _D = 21 A, T _J = 125 °C		10.7	13.5	1
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 21 A		50		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			1535	2150	pF
C _{oss}	Output Capacitance	─ V _{DS} = 40 V, V _{GS} = 0 V, f = 1 MHz		517	730	pF
C _{rss}	Reverse Transfer Capacitance			19	30	pF
R _g	Gate Resistance		0.1	0.4	0.8	Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			12	22	ns
t _r	Rise Time	V _{DD} = 40 V, I _D = 21 A,		3	10	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10 V, R _{GEN} = 6 Ω		18	32	ns
t _f	Fall Time	_		3	10	ns
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		21	29	nC
Qg	Total Gate Charge	$V_{GS} = 0 V$ to $6 V$ $V_{DD} = 40 V$,		13	18	nC
Q _{gs}	Gate to Source Charge	I _D = 21 A		6.7		nC
Q _{gd}	Gate to Drain "Miller" Charge			3.8		nC
Q _{oss}	Output Charge	V _{DD} = 40 V, V _{GS} = 0 V		28		nC
Q _{sync}	Total Gate Charge Sync.	V _{DS} = 0 V, I _D = 21 A		18		nC
Drain-Soເ	urce Diode Characteristics					
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A $ (Note 2) $V_{GS} = 0 V, I_S = 21 A $ (Note 2)		0.7	1.2 1.3	V
t _{rr}	Reverse Recovery Time			19	30	ns
Q _{rr}	Reverse Recovery Charge	—I _F = 10 A, di/dt = 300 A/μs		27	44	nC
<u>~n~</u>				45		

Q_{rr} Notes:

t_{rr}

1. $R_{0,JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0CA} is determined by the user's board design.

 $I_F = 10 \text{ A}, \text{ di/dt} = 1000 \text{ A/}\mu\text{s}$



Reverse Recovery Time

Reverse Recovery Charge

a. 53 °C/W when mounted on a 1 in² pad of 2 oz copper



b. 125 °C/W when mounted on a minimum pad of 2 oz copper

15

65

23

105

ns

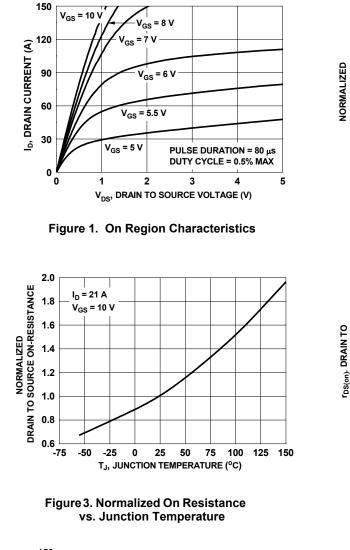
nC

2. Pulse Test: Pulse Width < $300 \ \mu$ s, Duty cycle < 2.0%. 3. E_{AS} of 150 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 10 A, V_{DD} = 10 V, V_{GS} = 80 V, 100% test at L = 0.1 mH, I_{AS} = 33 A. 4. Pulsed Id please refer to Fig 11 SOA graph for more details. 5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

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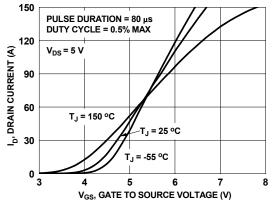
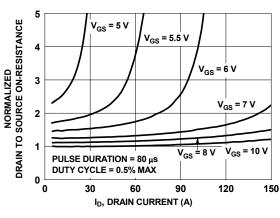
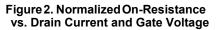


Figure 5. Transfer Characteristics





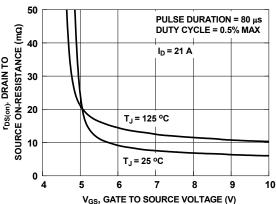
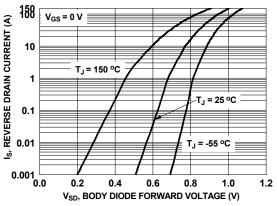
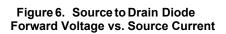
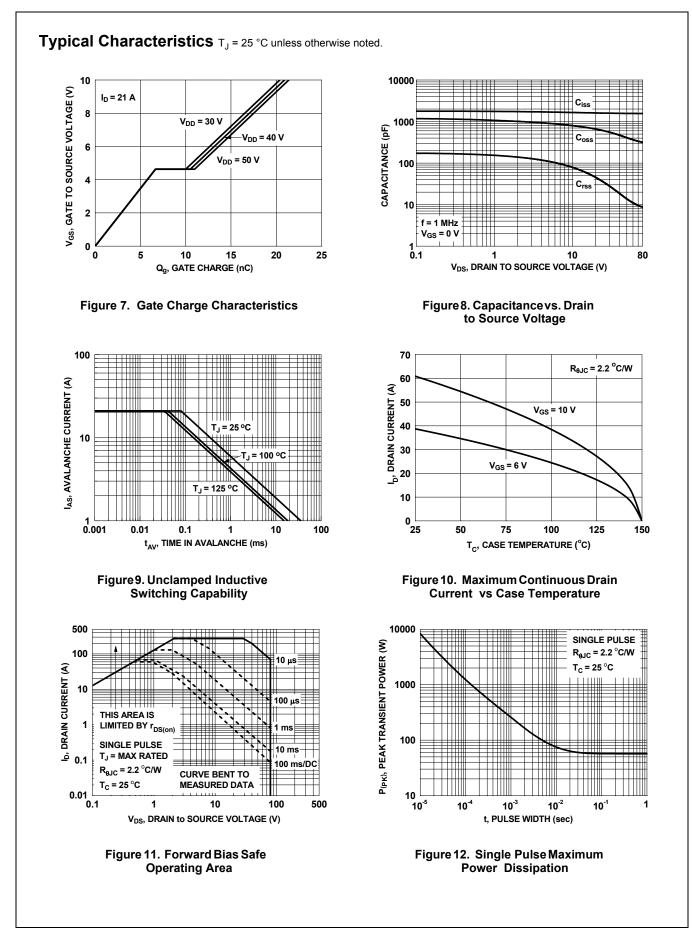
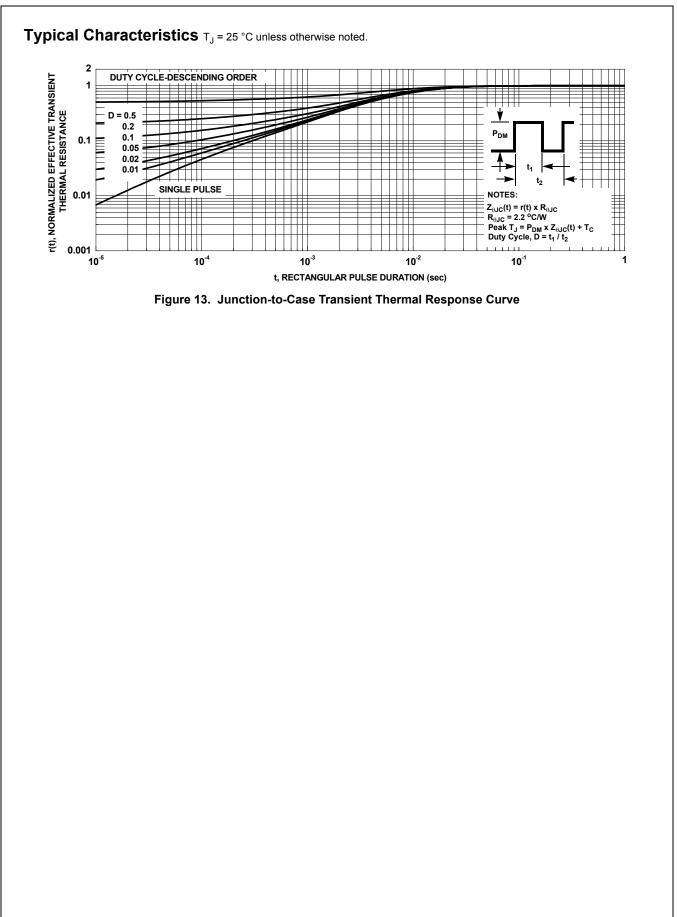


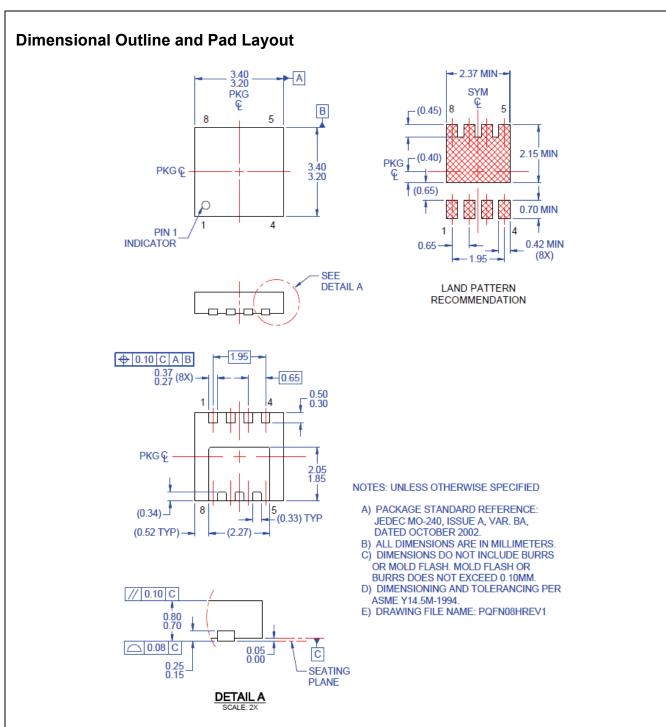
Figure 4. On-Resistance vs. Gate to Source Voltage







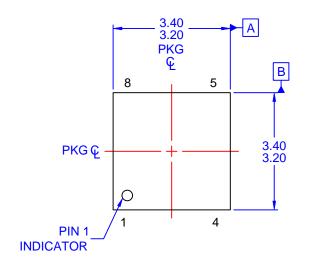


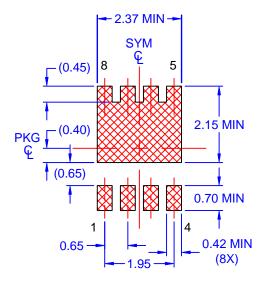


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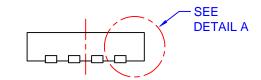
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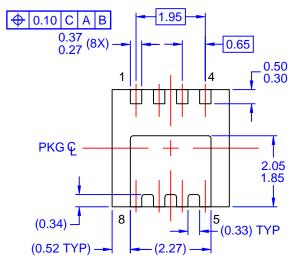
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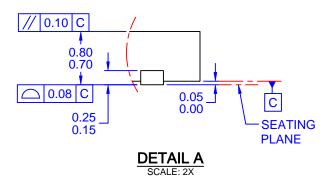












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